

N-Channel PowerTrench[®] MOSFET 60 V, 158 A, 2.5 m Ω

Features

- Max $r_{DS(on)}$ = 2.5 m Ω at V_{GS} = 10 V, I_D = 25 A
- Max $r_{DS(on)} = 3.7 \text{ m}\Omega$ at $V_{GS} = 4.5 \text{ V}$, $I_D = 20 \text{ A}$
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

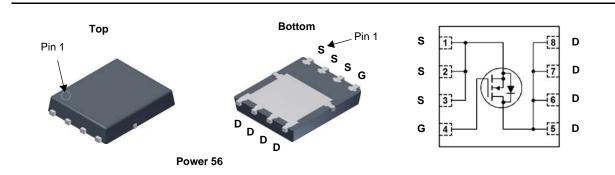


General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$, fast switching speed and body diode reverse recovery performance.

Applications

- Primary Switch in Isolated DC-DC
- Synchronous Rectifier
- Load Switch



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted.

| Symbol | Parameter | | | Ratings | Units | |
|-----------------------------------|--|-------------------------|-----------|-------------|-------|--|
| V _{DS} | Drain to Source Voltage | | | 60 | V | |
| V _{GS} | Gate to Source Voltage | | | ±20 | V | |
| | Drain Current -Continuous | T _C = 25 °C | (Note 5) | 158 | | |
| | -Continuous | T _C = 100 °C | (Note 5) | 100 | • | |
| ID | -Continuous | T _A = 25 °C | (Note 1a) | 25 | A | |
| | -Pulsed | | (Note 4) | 799 | | |
| E _{AS} | Single Pulse Avalanche Energy | | (Note 3) | 240 | mJ | |
| P _D | Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$ | | | 104 | 14/ | |
| | Power Dissipation | T _A = 25 °C | (Note 1a) | 2.5 | W | |
| T _J , T _{STG} | Operating and Storage Junction Temperature Range | | | -55 to +150 | °C | |

Thermal Characteristics

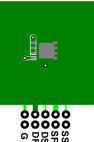
| $R_{	ext{	heta}JC}$ | Thermal Resistance, Junction-to-Case | 1.2 | °C/W |
|---------------------|---|-------|------|
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient (Note 1 | a) 50 | C/W |

Package Marking and Ordering Information

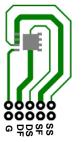
| Device Marking | Device | Package | Reel Size | Tape Width | Quantity | |
|----------------|------------|----------|-----------------|------------|------------|--|
| FDMS86500L | FDMS86500L | Power 56 | er 56 13 " 12 m | | 3000 units | |

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|--|---|--|------|--------------|---------------|----------|
| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Units |
| Off Chara | cteristics | | | | | |
| BV _{DSS} | Drain to Source Breakdown Voltage | I _D = 250 μA, V _{GS} = 0 V | 60 | | | V |
| ΔBV_{DSS} ΔT_J | Breakdown Voltage Temperature Coefficient | $I_D = 250 \ \mu$ A, referenced to 25 °C | | 30 | | mV/°C |
| IDSS | Zero Gate Voltage Drain Current | $V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 1 | μA |
| I _{GSS} | Gate to Source Leakage Current | $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ | | | ±100 | nA |
| On Chara | cteristics | | | | | |
| V _{GS(th)} | Gate to Source Threshold Voltage | $V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$ | 1 | 1.8 | 3 | V |
| $\frac{\Delta V_{GS(th)}}{\Delta T_J}$ | Gate to Source Threshold Voltage Temperature Coefficient | $I_D = 250 \ \mu\text{A}$, referenced to 25 °C | | -7 | | mV/°C |
| | Static Drain to Source On Resistance | V _{GS} = 10 V, I _D = 25 A | | 2.1 | 2.5 | |
| r _{DS(on)} | | $V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$ | | 2.9 | 3.7 | mΩ |
| | | V_{GS} = 10 V, I_{D} = 25 A, T_{J} = 125 °C | | 3.1 | 3.7 | |
| 9 _{FS} | Forward Transconductance | V _{DS} = 5 V, I _D = 20 A | | 95 | | S |
| C _{iss} C _{oss} | Characteristics Input Capacitance Output Capacitance | − V _{DS} = 30 V, V _{GS} = 0 V, f = 1 MHz | | 9420 1470 | 12530 1955 | pF pF |
| C _{rss} | Reverse Transfer Capacitance | | | 50 | 80 | pF |
| R _g | Gate Resistance | | 0.1 | 1.1 | 3.0 | Ω |
| Switching | g Characteristics | | | | | |
| t _{d(on)} | Turn-On Delay Time | | | 27 | 43 | ns |
| t _r | Rise Time | V _{DD} = 30 V, I _D = 25 A, | | 16 | 28 | ns |
| t _{d(off)} | Turn-Off Delay Time | $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ | | 63 | 100 | ns |
| t _f | Fall Time | | | 7.8 | 16 | ns |
| Q _g | Total Gate Charge | V _{GS} = 0 V to 10 V | | 117 | 165 | nC |
| Qg | Total Gate Charge | $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 30 \text{ V},$ $I_D = 25 \text{ A}$ | | 54 | 108 | nC |
| Q _{gs} | Gate to Source Charge | $I_{\rm D} = 25 \text{ A}$ | | 26.6 | | nC |
| Q _{gd} | Gate to Drain "Miller" Charge | | | 11.5 | | nC |
| Drain-Sou | urce Diode Characteristics | | | | | |
| | | $V_{GS} = 0 V, I_S = 2.1 A$ (Note 2) | | 0.68 | 1.2 | |
| V _{SD} | Source to Drain Diode Forward Voltage | $V_{GS} = 0 V, I_S = 25 A$ (Note 2) $V_{GS} = 0 V, I_S = 25 A$ (Note 2) | | 0.00 | 1.3 | V |
| t _{rr} | Reverse Recovery Time | | | 54 | 87 | ns |
| Q _{rr} | Reverse Recovery Charge | I _F = 25 A, di/dt = 100 A/μs | | 42 | 67 | nC |
| t _{rr} | Reverse Recovery Time | | | 46 | 73 | ns |
| -11 | Reverse Recovery Charge | — I _F = 25 A, di/dt = 300 A/μs | | 84 | 134 | nC |



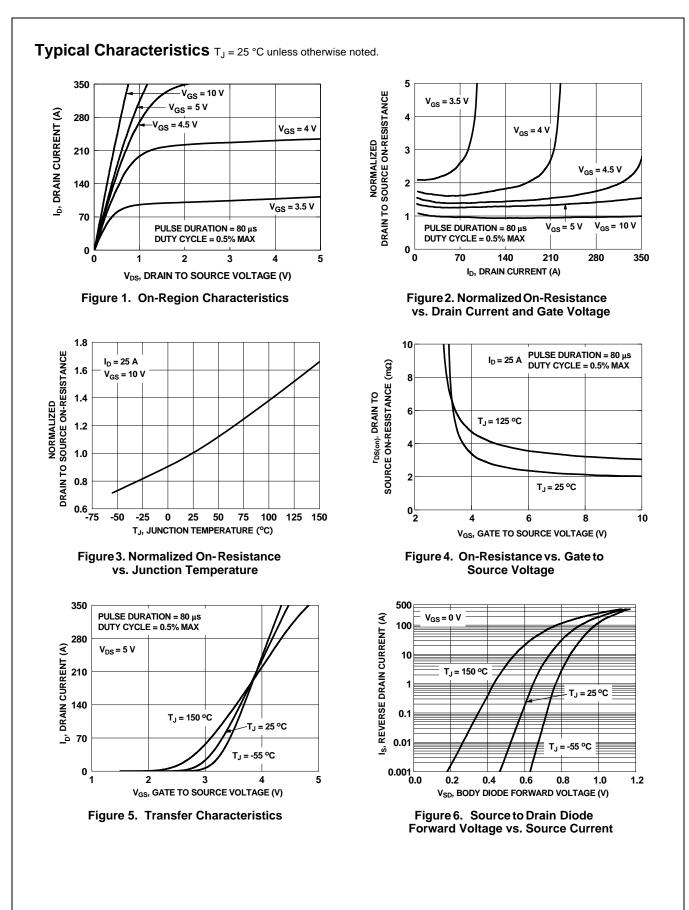
a) 50 °C/W when mounted on a 1 in² pad of 2 oz copper



b) 125 °C/W when mounted on a minimum pad of 2 oz copper.

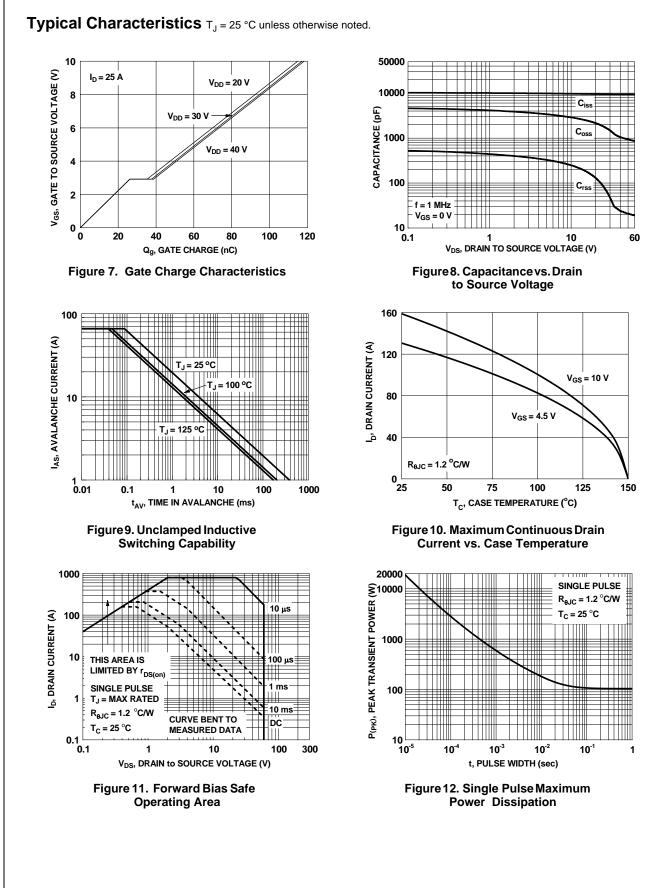
4. Pulsed Id please refer to Fig 11 SOA graph for more details.

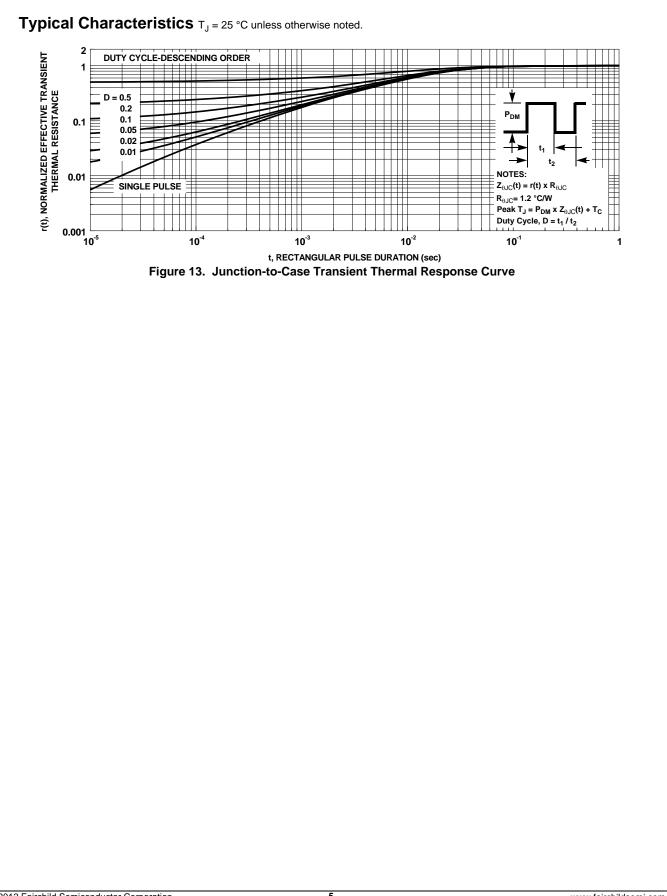
5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.



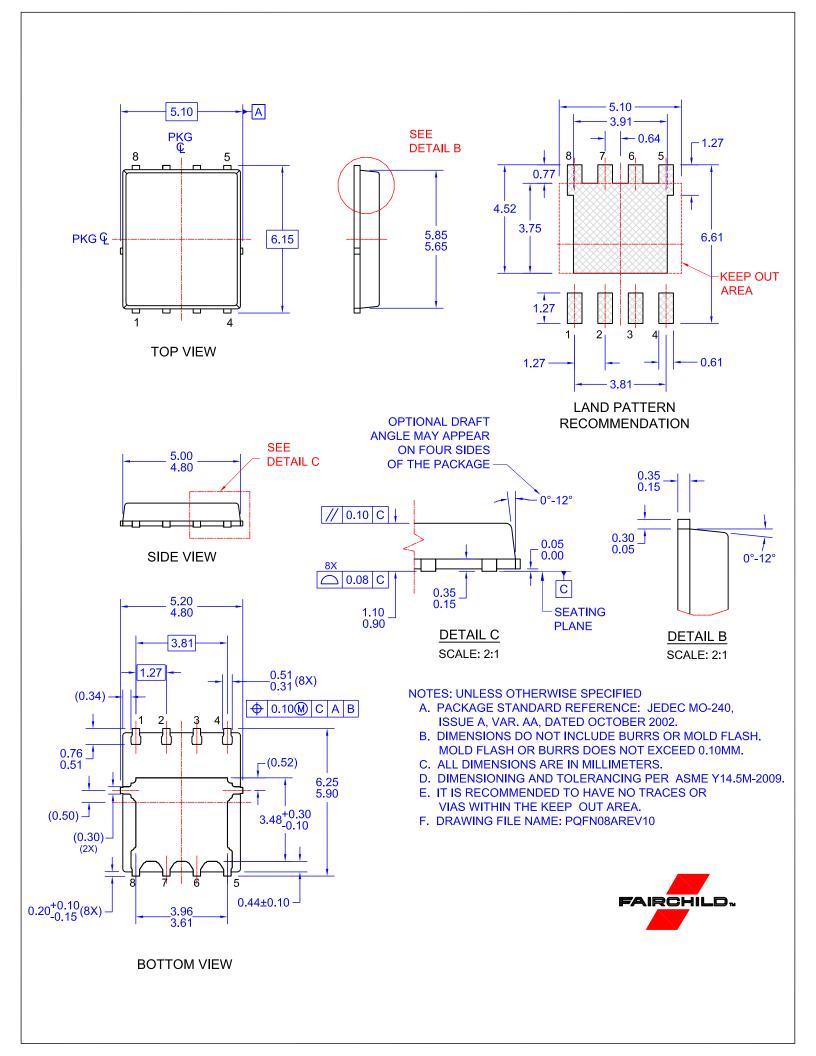
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FDMS86500L N-Channel PowerTrench[®] MOSFET





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